



## MBR730 - MBR750

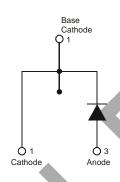
#### 7.5A SCHOTTKY BARRIER RECTIFIER

#### **Features**

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- High Surge Capability
- High Current Capability and Low Forward Voltage Drop
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)

## **Mechanical Data**

- Case: TO220AC
- Case Material: Molded Plastic. UL Flammability Classification
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Tin. Solderable per MIL-STD-202, Method 208 @3
- Polarity: See Diagram
- Marking: Type Number
- Weight: 2.3 grams (Approximate)



Package Pin Out Configuration

## Ordering Information (Note 3)

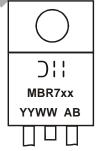
Part Number		Case	Packaging	
	MBR7xx*	TO220AC	50/Tube	

<sup>\*</sup> xx = Device type, e.g. MBR750

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
  2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



MBR7xx = Product Type Marking Code AB = Foundry and Assembly Code YYWW = Date Code Marking YY = Last two digits of year (ex: 10 = 2010)WW = Week (01 - 53)



# **Maximum Ratings** ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	MBR 730	MBR 740	MBR 750	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	40	50	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	21	28	35	V
Average Rectified Output Current (Note 4)	Io		7.5		Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>		150		Α

## **Thermal Characteristics**

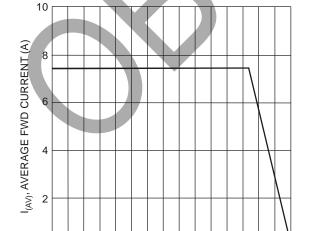
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Case (Note 4)	$R_{ heta JC}$	3.5	°C/W
Voltage Rate of Change (Rated V <sub>R</sub> )	dV/dt	10,000	V/µs
Operating Temperature Range	$T_J$	-55 to +150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +175	°C

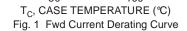
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteri	stic	Symbol	MBR 730	MBR 740	MBR 750	Unit
Forward Voltage Drop (Note 6)	@ I <sub>F</sub> = 7.5A, T <sub>J</sub> = +25°C @ I <sub>F</sub> = 7.5A, T <sub>J</sub> = +125°C @ I <sub>F</sub> = 15A, T <sub>J</sub> = +25°C @ I <sub>F</sub> = 15A, T <sub>J</sub> = +125°C	$V_{FM}$	0.	57 84 72	0.75 0.65 — —	V
Peak Reverse Current at Rated DC Blocking Voltage	@ T <sub>J</sub> = +25°C @ T <sub>J</sub> = +125°C		0 1	.1 5	0.5 50	mA
Typical Total Capacitance (Note 5)		C <sub>T</sub>		400		pF

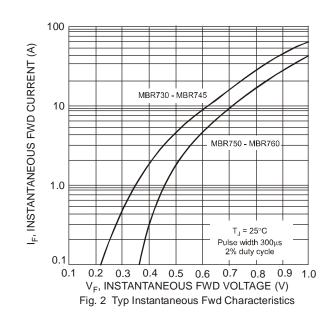
Notes:

- 4. Thermal resistance junction to case mounted on heatsink.
  5. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
  6. Short duration pulse test used to minimize self-heating effect.





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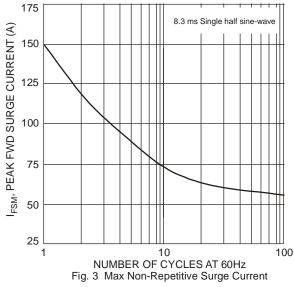
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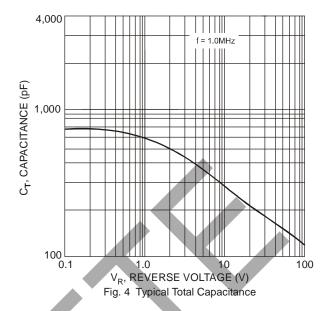
0

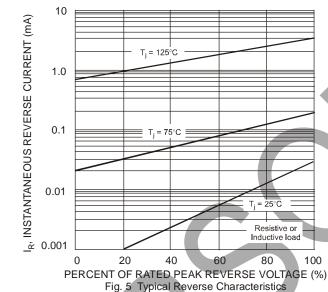
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## MBR730 - MBR750

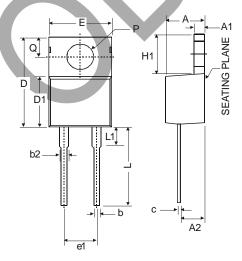






# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



TO220AC					
Dim	Min	Тур	Max		
Α	3.56	-	4.82		
A1	0.51	-	1.39		
A2	2.04	-	2.92		
b	0.39	0.81	1.01		
b2	1.15	1.24	1.77		
C	0.356	-	0.61		
D	14.22	-	16.51		
D1	8.39	-	9.01		
e1	5.08				
Е	9.66	10.66			
H1	5.85	-	6.85		
L	12.70	-	14.73		
L1	-	-	6.35		
Р	3.54	-	4.08		
q	2.54	-	3.42		
All Dimensions in mm					



MBR730 - MBR750

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